

ATTORNEY DOCKET NO. 50P4257.04

TION AND POWER OF ATTORNEY FOR NEW PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name. I believe that I am the original, first and sole inventor (if only one name is listed below) or an original first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

WIRELESS MODEM MODULE SERVER SYSTEM				
the specification of which: [] is attached hereto. [X] was filed on 10/5/01 as serial near and was amended on I hereby state that I have a specification including the claims, as I acknowledge the duty to diapplication in accordance with Title	reviewed and samended by isclose information	i understand the conter y any amendment referred mation which is material	to the examination of this	
I hereby claim foreign priorit application(s) for patent or inventor's application for patent or inventor's copriority is claimed.	y benefits un	der Title 35, United state sted below and have also	s Code, §119 of any foreign identified below any foreign	
Foreign Application(s), if any to the Filing Date of This Application Country Appli		r Inventor's Certificated F Date of Filing (day, month, year)	Priority Claimed Under 35 U.S.C.§119 [] YES [] NO	
All Foreign Applications, if any, for Patent or Inventor's Certificate Filed More Than 12 Month's Prior to the Filing Date of This Application: Country Application No. Date of Filing				
Contract 1 Mbb.				

I hereby claim foreign prior benefits under Title 35, United States Co. §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)

Number Country Day/Month/Year Filed Priority Claimed

__Yes __No

I hereby claim the benefit under Title 35, United States Code, §119 of any United States provisional application(s) listed below.

<u>U.S. Provisional Application Number</u> 60/240,011

Filing Date
October 13, 2000

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which became available between the Filing date of the prior application and the national or PCT international Filing date of this application.

Application		Status	
Serial No.	Date of Filing	patented, pending abandoned	

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

Peter C. Toto	Reg. No. 36,293
Jaime A. Siegel	Reg. No. 39,027
Harold T. Fujii	Reg. No. 38,458
Frederick J. Zustak	Reg. No. 36,728
Mark Gorman	Reg. No. 43,641
Aditya Krishnan	Reg. No. 41,531
Ronald C. Card	Reg. No. 44,587
Milton M. Frazier	Reg. No. 44,687

Send Correspondence and direct telephone calls to:

Sony Electronics Inc. 16450 West Bernardo Drive, MZ 7190 San Diego, CA 92127-1898

Telephone: (858) 942-2897 Fax: (858) 942-7120 I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 of the U.S. Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Inventor's signature

Akihiko Toyoshima

Name of sole or first inventor

Tokyo, Japan

Residence (City, State)

5-17-3 Minami-Senju, Arakawa-ku

Post Office Address

Japan

Citizenship